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GS1528 HD-LINX II Multi-Rate SDI Dual Slew-Rate Cable Driver

Features

- SMPTE 292M, SMPTE 344M and SMPTE 259M compliant
- dual coaxial cable driving outputs with selectable slew rate
- 50Ω differential PECL input
- seamless interface to other HD-LINX® II family products
- Pb-free and RoHS Compliant
- single 3.3V power supply operation
- operating temperature range: 0°C to 70°C

Applications

• SMPTE 292M, SMPTE 344M and SMPTE 259M Coaxial Cable Serial Digital Interfaces.

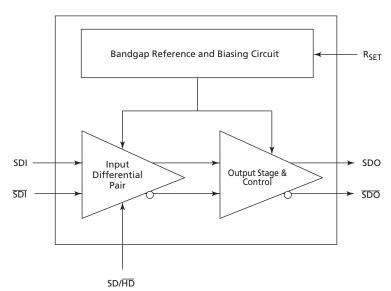
Description

The GS1528 is a second generation high-speed bipolar integrated circuit designed to drive one or two 75Ω co-axial cables at data rates up to 1.485Gb/s. The GS1528 provides two selectable slew rates in order to achieve compliance to SMPTE 259M, SMPTE 344M and SMPTE 292M.

The GS1528 accepts a LVPECL level differential input that may be AC-coupled. External biasing resistors at the inputs are not required.

Power consumption is typically 160mW using a 3.3V power supply.

This component and all homogeneous subcomponents are RoHS compliant.



Functional Block Diagram

August 2010

Revision History

Version	ECR	PCN	Date	Changes and / or Modifications
9	154748	-	August 2010	Corrected Figure 5-1: Package Dimensions.
8	152046	-	June 2009	Removed 'Proprietary & Confidential' from footer.
7	151340	-	February 2009	Updated document format. Added 2,500pc reel, and removed leaded parts in section 5.1 Ordering Information.
6	139116	38124	January 2006	Corrected Serial Input Swing to 2200mV
5	137163	-	June 2005	Rephrased RoHS compliance statement.
4	136566	-	April 2005	Updated 'Green' references to RoHS Compliant.

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1. Electrical Characteristics

1.1 Absolute Maximum Ratings

 $T_A = 25$ °C unless otherwise indicated

Parameter	Value
Supply Voltage	-0.5V to 3.6 V _{DC}
Input ESD Voltage	500V
Storage Temperature Range	-50°C < T _s < 125°C
Input Voltage Range (any input)	-0.3 to (V _{CC} +0.3)V
Operating Temperature Range	0°C to 70°C
Power Dissipation	300mW
Lead Temperature (soldering, 10 sec)	260°C

CAUTION The GS1528 is sensitive to electrostatic discharge. Use extreme caution, observing all ESD-prevention practices, during handling and assembly. The SDI inputs of the GS1528 must be protected from electrostatic discharge and electrical overstress during the handling and operation of circuit assemblies

1.2 DC Electrical Characteristics

Table 1-1: DC Electrical Characteristics

 $V_{DD} = 3.3V$, $T_A = 0$ °C to 70°C, unless otherwise shown

Parameter	Conditions	Symbol	Min	Тур	Max	Units	Notes	Test Levels
Supply Voltage		V _{CC}	3.135	3.3	3.465	V	±5%	3
Power Consumption	T _A = 25°C	P_{D}	-	160	-	mW		5
Supply Current	T _A = 25°C	I _S	_	48	-	mA		1
Output Voltage	Common mode	V _{CMOUT}	-	V _{CC} - V _{OUT}	_	_		6
Input Voltage	Common mode	V _{CMIN}	1.6 + ∆V _{SDI} /2	_	V _{CC} - ∆V _{SDI} /2	V		5
SD/HD Input		V _{IH}	2.4	_	-	V		7
		V _{IL}	-	-	0.8	V		7



1.3 AC Electrical Characteristics

Table 1-2: AC Electrical Characteristics

 V_{DD} = 3.3V, T_A = 0°C to 70°C, unless otherwise shown

Parameter	Conditions	Symbol	Min	Тур	Max	Units	Notes	Test Levels
Serial input data rate		DR _{SDO}	-	-	1.485	Gb/s	2	1
Additive jitter	1.485Gb/s		-	15	_	ps _{p-p}		1
	270Mb/s		-	25	_	ps _{p-p}		1
Rise/Fall time	SD/HD=0	t _r , t _f	-	-	220	ps	20% to 80%	1
	SD/HD=1	t _r , t _f	400	-	800	ps	20% to 80%	1
Mismatch in rise/fall time		$\triangle t_{r} \triangle t_{f}$	_	_	30	ps		1
Duty cycle distortion			-	_	30	ps		1
Overshoot			_	-	8	%		1
Output Return Loss		ORL	15	-	-	dB	1	7
Output Voltage Swing	Single Ended into 75Ω external load $R_{SET} = 750\Omega$	V _{OUT}	750	800	850	mV _{p-p}		1
Input Voltage Swing	Differential	$\triangle V_{SDI}$	300	_	2200	mV _{p-p}		1

TEST LEVELS

- 1. Production test at room temperature and nominal supply voltage with guardbands for supply and temperature ranges.
- 2. Production test at room temperature and nominal supply voltage with guardbands for supply and temperature ranges using correlated test.
- 3. Production test at room temperature and nominal supply voltage.
- 4. QA sample test.
- 5. Calculated result based on Level 1, 2, or 3.
- 6. Not tested. Guaranteed by design simulations.
- 7. Not tested. Based on characterization of nominal parts.
- 8. Not tested. Based on existing design/characterization data of similar product.
- 9. Indirect test.

NOTES:

- 1. Tested on CB1528 board from 5MHz to 1.435GHz
- 2. The input coupling capacitor must be set accordingly for lower data rates.



2. Pin Out

2.1 Pin Assignment

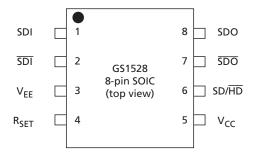


Figure 2-1: 8-Pin SOIC

2.2 Pin Descriptions

Table 2-1: Pin Descriptions

Pin Number	Name	Туре	Description		
1,2	SDI, SDI	PECL INPUT	Serial digital differential input.		
3	V_{EE}	POWER Most negative power supply connection. Connect to GND.			
4	R _{SET}	INPUT	External output amplitude control resistor.		
5	V _{CC}	POWER Most positive power supply connection. Connect to +3.3V.			
6	SD/HD	LOGIC INPUT	Output slew rate control. When HIGH, the output will meet SMPTE259M rise/fall time specifications. When LOW, the serial outputs will meet SMPTE292M rise/fall time specifications.		
7, 8	SDO, SDO	OUTPUT	Serial digital differential output.		



2.3 Input/Output Circuits

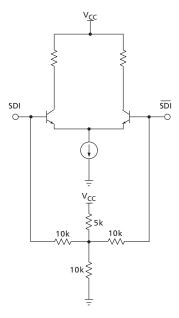


Figure 2-2: Differential Input Stage (SDI/SDI)

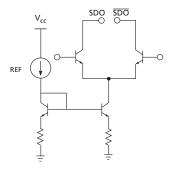


Figure 2-3: Differential Output Stage (SDO/ $\overline{\text{SDO}}$) I_{REF} derived using R_{SET}

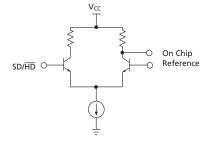


Figure 2-4: Slew Rate Select Input Stage (SD/HD)



3. Detailed Description

3.1 Input Interfacing

SDI/SDI are high-impedance differential inputs (see Figure 2-1 for equivalent input circuit).

Several conditions must be observed when interfacing to these inputs:

- 1. The differential input signal amplitude must be between 300 and 2000mVpp.
- 2. The common mode voltage range must be as specified in Table 1-1: DC Electrical Characteristics.
- 3. For input trace lengths longer than approximately 1cm, the inputs should be terminated as shown in the Typical Application Circuit.

The GS1528 inputs are self-biased, allowing for simple AC-coupling to the device. For serial digital video, a minimum capacitor value of $4.7\mu F$ should be used to allow coupling of pathological test signals. A tantalum capacitor is recommended.

3.2 SD/HD

The GS1528 SDO rise and fall times can be set to comply with both SMPTE 259M/344M and SMPTE 292M. For all SMPTE 259M standards, or any data rate that requires longer rise and fall time characteristics, the SD/HD pin must be set to a HIGH INPUT. For SMPTE 292M standards and signals which require faster rise and fall times, this pin should be set to a LOW INPUT.

3.3 Output Interfacing

The GS1528 outputs are current mode, and will drive 800 mV into a 75Ω load. These outputs are protected from accidental static damage with internal static protection diodes.

The SMPTE 292M, SMPTE 344M and SMPTE 259M standards requires that the output of a cable driver have a source impedance of 75Ω and a return loss of at least 15dB between 5MHz and 1.485GHz.

In order for an SDI output circuit using the GS1528 to meet this specification, the output circuit shown in the Typical Application Circuit is recommended.

The value of L_{COMP} will vary depending on the PCB layout, with a typical value of 5.6nH (see the Application Information on page 11 in this data sheet for further details). A 4.7 μ F capacitor is used for AC-coupling the output of the GS1528. This value is chosen to ensure that pathological signals can be coupled without a significant DC component occurring.



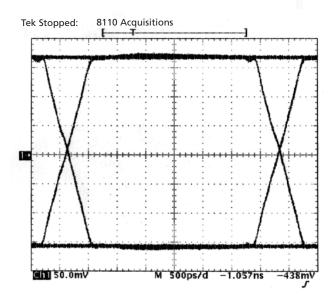


Figure 3-1: Output signal for 270Mb/s input

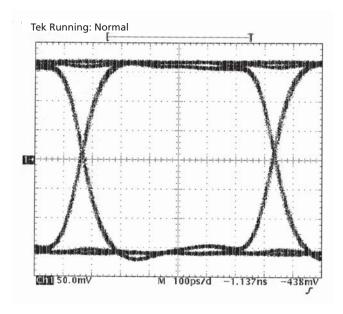


Figure 3-2: Output signal for 1.485Gb/s input

When measuring return loss at the GS1528 output, it is necessary to take the measurement for both a logic high and a logic low output condition. This is because the output protection diodes act as varactors (voltage controlled capacitors) as shown in Figure 3-3.

Consequently, the output capacitance of the $\mathsf{GS1528}$ is dependent on the logic state of the output.



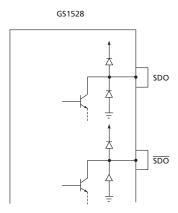


Figure 3-3: Static Protection Diodes

3.4 Output Return Loss Measurement

To perform a practical return loss measurement, it is necessary to force the GS1528 output to a DC high or low condition. The actual measured return loss will be based on the outputs being static at V_{CC} or V_{CC} -1.6V. Under normal operating conditions the outputs of the GS1528 swing between V_{CC} -0.4V and V_{CC} -1.2V, so the measured value of return loss will not represent the actual operating return loss.

A simple method of calculating the values of actual operating return loss is to interpolate the two return loss measurements. In this way, the values of return loss are estimated at V_{CC} -0.4V and V_{CC} -1.2V based on the measurements at V_{CC} and V_{CC} -1.6V.

The two values of return loss (high and low) will typically differ by several decibels. If the measured return loss is R_H for logic high and R_L for logic low, then the two values can be interpolated as follows:

$$R_{IH} = R_H - (R_H - R_L)/4$$
 and

$$R_{II} = R_I + (R_H - R_I)/4$$

Where R_{IH} is the interpolated logic high value and R_{IL} is the interpolated logic low value.

For example: if R_H = -18dB and R_L = -14dB, then the interpolated values are R_{IH} = -17dB and R_{IL} = -15dB.



3.5 Output Amplitude Adjustment

The output amplitude of the GS1528 can be adjusted by changing the value of the R_{SET} resistor as shown in Figure 3-4 and Table 3-1. For an $800 mV_{p-p}$ output with a nominal $\pm 7\%$ tolerance, a value of 750Ω is required. A $\pm 1\%$ SMT resistor should be used.

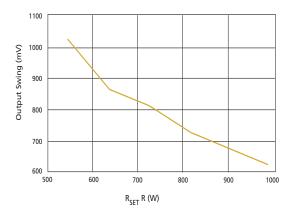


Figure 3-4: Output Amplitude Adjustment

The R_{SET} resistor is part of the high-speed output circuit of the GS1528. The resistor should be placed as close as possible to the R_{SET} pin. In addition, the PCB capacitance should be minimized at this node by removing the PCB ground plane beneath the R_{SET} resistor and the R_{SET} pin.

Table 3-1: R_{SET} vs. V_{OD}

R _{SET} Resistance (Ω)	Output Swing
995	608
824	734
750	800
600	884
573	1040

NOTE: For reliable operation of the GS1528 over the full temperature range, do not use an R_{SET} value below 573 Ω .



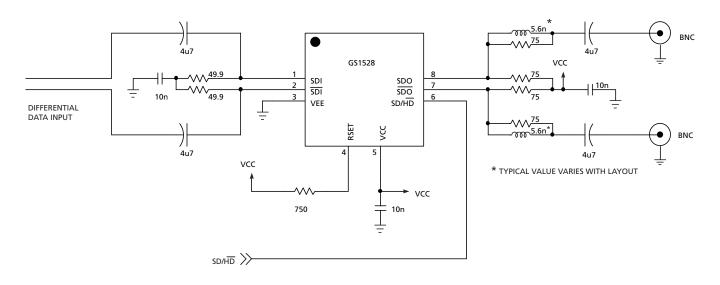
4. Application Information

4.1 PCB Layout

Special attention must be paid to component layout when designing serial digital interfaces for HDTV. An FR-4 dielectric can be used, however, controlled impedance transmission lines are required for PCB traces longer than approximately 1cm. Note the following PCB artwork features used to optimize performance:

- The PCB trace width for HD rate signals is closely matched to SMT component width to minimize reflections due to changes in trace impedance
- The PCB groundplane is removed under the GS1528 output components to minimize parasitic capacitance
- The PCB ground plane is removed under the GS1528 $R_{\mbox{\footnotesize SET}}$ pin and resistor to minimize parasitic capacitance
- Input and output BNC connectors are surface-mounted in-line to eliminate transmission line stubs caused by a BNC mounting via high-speed traces, which are curved to minimize impedance variations due to change of PCB trace width

4.2 Typical Application Circuit

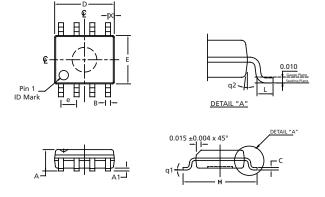


NOTE: All resistors in Ohms, capacitors in Farads, and inductors in Henrys, unless otherwise noted.

Figure 4-1: GS1528 Typical Application Circuit



5. Package Dimensions



SYMBOL	8 SOIC				
SYM	Min.	Max.			
Α	0.054	0.068			
A1	0.004	0.0098			
В	0.014	0.019			
D	0.189	0.196			
Е	0.150	0.157			
Н	0.229	0.244			
е	0.050) BSC			
С	0.0075	0.0098			
L	0.016	0.034			
Х	0.0215 REF				
q1	0°	8°			
q2	7° BSC				

- NOTES:

 1. All dimensions in inches unless otherwise stated.
 2. Lead coplanarity should be 0 to 0.004" max.
 3. Package surface finishing: VDI 24–27 (dual).
 Package surface finishing: VDI 13–15 (16L SOLC[NB] matrix).
 4. All dimensions exclude mold flashes.
 5. The lead width (8) to be determined at 0.0075" from the lead tip.

Figure 5-1: Package Dimensions

5.1 Ordering Information

Part Number	Package	Temperature	Pb-Free and RoHS Compliant
GS1528-CKAE3	8 pin SOIC	0°C to 70°C	Yes
GS1528-CTAE3	8 pin SOIC, tape & reel (250pc)	0°C to 70°C	Yes
GS1528-CTAE3Z	8 pin SOIC, tape & reel (2,500pc)	0°C to 70°C	Yes



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